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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	33
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	368 x 8
Voltage - Supply (Vcc/Vdd)	4V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-MQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f877-20i-pq

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FI	GU	IRF	2-3	-
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PIC16F877/876 REGISTER FILE MAP

Indirect addr.(*)	00h	Indirect addr.(*)	80h	Indirect addr.(*)	100h	Indirect addr.(*)	18
TMR0	01h	OPTION_REG	81h	TMR0	101h	OPTION_REG	18
PCL	02h	PCL	82h	PCL	102h	PCL	182
STATUS	03h	STATUS	83h	STATUS	103h	STATUS	183
FSR	04h	FSR	84h	FSR	104h	FSR	184
PORTA	05h	TRISA	85h		105h		18
PORTB	06h	TRISB	86h	PORTB	106h	TRISB	186
PORTC	07h	TRISC	87h		107h		187
PORTD ⁽¹⁾	08h	TRISD ⁽¹⁾	88h		108h		188
PORTE ⁽¹⁾	09h	TRISE ⁽¹⁾	89h		109h		189
PCLATH	0Ah	PCLATH	8Ah	PCLATH	10Ah	PCLATH	18/
INTCON	0Bh	INTCON	8Bh	INTCON	10Bh	INTCON	18
PIR1	0Ch	PIE1	8Ch	EEDATA	10Ch	EECON1	180
PIR2	0Dh	PIE2	8Dh	EEADR	10Dh	EECON2	181
TMR1L	0Eh	PCON	8Eh	EEDATH	10Eh	Reserved ⁽²⁾	18
TMR1H	0Fh		8Fh	EEADRH	10Fh	Reserved ⁽²⁾	18
T1CON	10h		90h		110h		190
TMR2	11h	SSPCON2	91h		111h		19 [.]
T2CON	12h	PR2	92h		112h		192
SSPBUF	13h	SSPADD	93h		113h		193
SSPCON	14h	SSPSTAT	94h		114h		194
CCPR1L	15h		95h		115h		19
CCPR1H	16h		96h		116h		196
CCP1CON	17h		97h	General	117h	General	197
RCSTA	18h	TXSTA	98h	Purpose Register	118h	Purpose Register	198
TXREG	19h	SPBRG	99h	16 Bytes	119h	16 Bytes	199
RCREG	1Ah		9Ah	-	11Ah		19/
CCPR2L	1Bh		9Bh		11Bh		198
CCPR2H	1Ch		9Ch		11Ch		190
CCP2CON	1Dh		9Dh		11Dh		19[
ADRESH	1Eh	ADRESL	9Eh		11Eh		19
ADCON0	1Fh	ADCON1	9Fh		11Fh		191
	20h		A0h		120h		1A
General Purpose Register		General Purpose Register 80 Bytes		General Purpose Register 80 Bytes		General Purpose Register 80 Bytes	
96 Bytes		UU Dyico	EFh	00 Dytos	16Fh	00 Dyi00	1EI
	7Fh	accesses 70h-7Fh	F0h FFh	accesses 70h-7Fh	170h 17Fh	accesses 70h - 7Fh	1F(1Fl
Bank 0		Bank 1	FFII	Bank 2	/. !!	Bank 3	11.1
1 1 m 1 m 1	بارار منعم	a memory location	a				

2: These registers are reserved, maintain these registers clear.

2.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. A list of these registers is given in Table 2-1. The Special Function Registers can be classified into two sets: core (CPU) and peripheral. Those registers associated with the core functions are described in detail in this section. Those related to the operation of the peripheral features are described in detail in the peripheral features section.

 TABLE 2-1:
 SPECIAL FUNCTION REGISTER SUMMARY

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Details on page:
Bank 0											
00h ⁽³⁾	INDF	Addressing	g this locatio	egister)	0000 0000	27					
01h	TMR0	Timer0 Mc	mer0 Module Register								47
02h ⁽³⁾	PCL	Program C	Counter (PC)	Least Signif	icant Byte					0000 0000	26
03h ⁽³⁾	STATUS	IRP	RP1	RP0	TO	PD	Z	DC	С	0001 1xxx	18
04h ⁽³⁾	FSR	Indirect Da	ata Memory /	Address Poir	nter					xxxx xxxx	27
05h	PORTA	_	_	PORTA Da	ta Latch whe	n written: POI	RTA pins whe	n read		0x 0000	29
06h	PORTB	PORTB Da	ata Latch wh	en written: P	ORTB pins w	/hen read				xxxx xxxx	31
07h	PORTC	PORTC D	ata Latch wh	en written: F	ORTC pins v	vhen read				xxxx xxxx	33
08h ⁽⁴⁾	PORTD	PORTD D	ata Latch wh	en written: F	ORTD pins v	vhen read				xxxx xxxx	35
09h ⁽⁴⁾	PORTE	_	_	_	_	_	RE2	RE1	RE0	xxx	36
0Ah ^(1,3)	PCLATH	_			Write Buffer	for the upper	r 5 bits of the I	Program Cou	unter	0 0000	26
0Bh ⁽³⁾	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	20
0Ch	PIR1	PSPIF ⁽³⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	22
0Dh	PIR2	—	(5)	_	EEIF	BCLIF	—		CCP2IF	-r-0 00	24
0Eh	TMR1L	Holding re	Holding register for the Least Significant Byte of the 16-bit TMR1 Register								52
0Fh	TMR1H	Holding re	gister for the	Most Signifi	cant Byte of t	the 16-bit TM	R1 Register			xxxx xxxx	52
10h	T1CON	_	_	T1CKPS1	T1CKPS0	T1OSCEN	T1SYNC	TMR1CS	TMR10N	00 0000	51
11h	TMR2	Timer2 Mo	dule Registe	er						0000 0000	55
12h	T2CON	_	TOUTPS3	TOUTPS2	TOUTPS1	TOUTPS0	TMR2ON	T2CKPS1	T2CKPS0	-000 0000	55
13h	SSPBUF	Synchrono	ous Serial Po	rt Receive B	uffer/Transm	it Register				xxxx xxxx	70, 73
14h	SSPCON	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	67
15h	CCPR1L	Capture/C	ompare/PWI	M Register1	(LSB)					XXXX XXXX	57
16h	CCPR1H	Capture/C	ompare/PWI	M Register1	(MSB)					XXXX XXXX	57
17h	CCP1CON	_	_	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0	00 0000	58
18h	RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	96
19h	TXREG	USART Tr	ansmit Data	Register						0000 0000	99
1Ah	RCREG	USART Re	USART Receive Data Register							0000 0000	101
1Bh	CCPR2L	Capture/C	Capture/Compare/PWM Register2 (LSB)							xxxx xxxx	57
1Ch	CCPR2H	Capture/C								xxxx xxxx	57
1Dh	CCP2CON	_	_	CCP2X	CCP2Y	CCP2M3	CCP2M2	CCP2M1	CCP2M0	00 0000	58
1Eh	ADRESH	A/D Result	t Register Hi	gh Byte						xxxx xxxx	116
1Fh	ADCON0	ADCS1	ADCS0	CHS2	CHS1	CHS0	GO/DONE	_	ADON	0000 00-0	111

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved.

Shaded locations are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for the PC<12:8> whose contents are transferred to the upper byte of the program counter.

2: Bits PSPIE and PSPIF are reserved on PIC16F873/876 devices; always maintain these bits clear.

3: These registers can be addressed from any bank.

4: PORTD, PORTE, TRISD, and TRISE are not physically implemented on PIC16F873/876 devices; read as '0'.

5: PIR2<6> and PIE2<6> are reserved on these devices; always maintain these bits clear.

PIC16F87X

2.2.2.5 PIR1 Register

The PIR1 register contains the individual flag bits for the peripheral interrupts.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt bits are clear prior to enabling an interrupt.

	R/W-0	R/W-0	R-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0			
	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF			
	bit 7							bit 0			
bit 7		or a write o	peration has		rupt Flag bit e (must be c	leared in sof	ítware)				
bit 6	1 = An A/D	ADIF: A/D Converter Interrupt Flag bit 1 = An A/D conversion completed 0 = The A/D conversion is not complete									
bit 5		SART receiv	e buffer is f	ull							
bit 4	TXIF: USAI 1 = The US	 0 = The USART receive buffer is empty TXIF: USART Transmit Interrupt Flag bit 1 = The USART transmit buffer is empty 0 = The USART transmit buffer is full 									
bit 3	1 = The SSI from the • SPI - A • I ² C S	P interrupt o e Interrupt S A transmiss Slave A transmiss		s occurred, a tine. The co n has taken	and must be nditions that place.	cleared in so		e returning			
	T - T - T - T - A - A - A	The initiated The initiated The initiated The initiated A START co A STOP cor	I STOP cone I Restart cor I Acknowled Indition occu	ndition was of dition was condition was ge condition Irred while the red while the	completed by completed by completed by was completed by was completed by	y the SSP m the SSP mc y the SSP m eted by the S ule was idle (ile was idle (odule. odule. SSP module (Multi-Maste	r system).			
bit 2	CCP1IF: CO	•									
	0 = No TMF <u>Compare m</u> 1 = A TMR ⁻	1 register ca R1 register <u>node:</u> 1 register ca R1 register <u>2:</u>	capture occ	urred ch occurred		software) eared in soft	ware)				
bit 1	1 = TMR2 t	o PR2 mate	2 Match Inte ch occurred natch occur	(must be cle	it eared in soft	ware)					
bit 0	1 = TMR1 r	egister ove	ow Interrupt rflowed (mu not overflow	st be cleare	d in software	e)					
	Note 1: P	SPIF is res	erved on PI	C16F873/87	76 devices; a	always maint	ain this bit c	lear.			
	Legend:										
	R = Reada	ole bit	W = Writat		U = Unimp	lemented bit	t, read as '0'				
	- n = Value	at POR	'1' = Bit is	set	'0' = Bit is	cleared	x = Bit is ur	nknown			

REGISTER 2-5: PIR1 REGISTER (ADDRESS 0Ch)

2.5 Indirect Addressing, INDF and FSR Registers

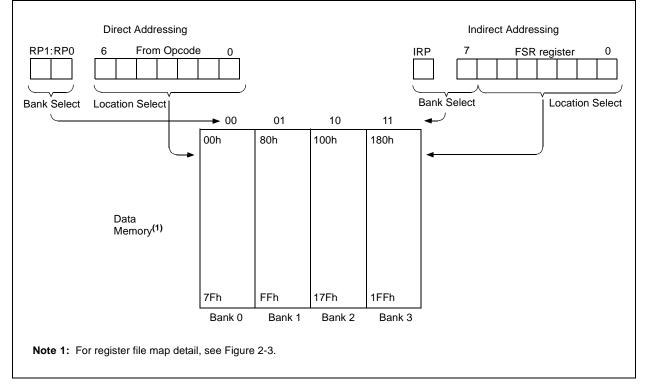
The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses the register pointed to by the File Select Register, FSR. Reading the INDF register itself, indirectly (FSR = '0') will read 00h. Writing to the INDF register indirectly results in a no operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 2-6. A simple program to clear RAM locations 20h-2Fh using indirect addressing is shown in Example 2-2.

EXAMPLE 2-2: INDIRECT ADDRESSING

	MOVLW	0x20	;initialize pointer
	MOVWF	FSR	;to RAM
NEXT	CLRF	INDF	clear INDF register;
	INCF	FSR,F	;inc pointer
	BTFSS	FSR,4	;all done?
	GOTO	NEXT	;no clear next
CONTINUE			
	:		;yes continue





Name	Bit#	Buffer	Function
RA0/AN0	bit0	TTL	Input/output or analog input.
RA1/AN1	bit1	TTL	Input/output or analog input.
RA2/AN2	bit2	TTL	Input/output or analog input.
RA3/AN3/VREF	bit3	TTL	Input/output or analog input or VREF.
RA4/T0CKI	bit4	ST	Input/output or external clock input for Timer0. Output is open drain type.
RA5/SS/AN4	bit5	TTL	Input/output or slave select input for synchronous serial port or analog input.

TABLE 3-1: PORTA FUNCTIONS

Legend: TTL = TTL input, ST = Schmitt Trigger input

TABLE 3-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
05h	PORTA	—		RA5	RA4	RA3	RA2	RA1	RA0	0x 0000	0u 0000
85h	TRISA	—	_	PORTA Data Direction Register11 111111 1111							
9Fh	ADCON1	ADFM		_		PCFG3	PCFG2	PCFG1	PCFG0	0- 0000	0-0000

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTA.

Note: When using the SSP module in SPI Slave mode and \overline{SS} enabled, the A/D converter must be set to one of the following modes, where PCFG3:PCFG0 = 0100,0101, 011x, 1101, 1110, 1111.

3.3 PORTC and the TRISC Register

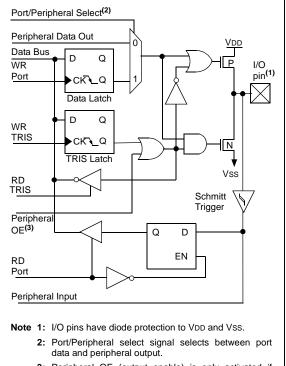
PORTC is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISC. Setting a TRISC bit (= 1) will make the corresponding PORTC pin an input (i.e., put the corresponding output driver in a Hi-Impedance mode). Clearing a TRISC bit (= 0) will make the corresponding PORTC pin an output (i.e., put the contents of the output latch on the selected pin).

PORTC is multiplexed with several peripheral functions (Table 3-5). PORTC pins have Schmitt Trigger input buffers.

When the I^2C module is enabled, the PORTC<4:3> pins can be configured with normal I^2C levels, or with SMBus levels by using the CKE bit (SSPSTAT<6>).

When enabling peripheral functions, care should be taken in defining TRIS bits for each PORTC pin. Some peripherals override the TRIS bit to make a pin an output, while other peripherals override the TRIS bit to make a pin an input. Since the TRIS bit override is in effect while the peripheral is enabled, read-modify-write instructions (BSF, BCF, XORWF) with TRISC as destination, should be avoided. The user should refer to the corresponding peripheral section for the correct TRIS bit settings.

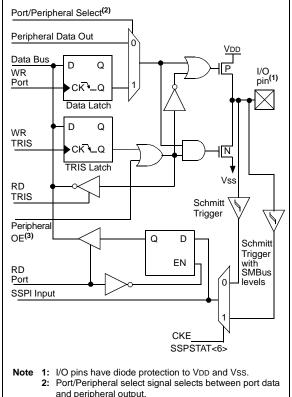
FIGURE 3-5: PORTC BLOCK DIAGRAM (PERIPHERAL OUTPUT OVERRIDE) RC<2:0>, RC<7:5>



3: Peripheral OE (output enable) is only activated if peripheral select is active.

FIGURE 3-6:

PORTC BLOCK DIAGRAM (PERIPHERAL OUTPUT OVERRIDE) RC<4:3>



 Peripheral OE (output enable) is only activated if peripheral select is active.

4.9 FLASH Program Memory Write Protection

The configuration word contains a bit that write protects the FLASH program memory, called WRT. This bit can only be accessed when programming the PIC16F87X device via ICSP. Once write protection is enabled, only an erase of the entire device will disable it. When enabled, write protection prevents any writes to FLASH program memory. Write protection does not affect program memory reads.

TABLE 4-1: READ/WRITE STATE OF INTERNAL FLASH PROGRAM MEMORY

Со	figuration Bits		Manageral	Internal	Internal			
CP1	CP0	WRT	Memory Location	Read	Write	ICSP Read	ICSP Write	
0	0	x	All program memory	Yes	No	No	No	
0	1	0	Unprotected areas	Yes	No	Yes	No	
0	1	0	Protected areas	Yes	No	No	No	
0	1	1	Unprotected areas	Yes	Yes	Yes	No	
0	1	1	Protected areas	Yes	No	No	No	
1	0	0	Unprotected areas	Yes	No	Yes	No	
1	0	0	Protected areas	Yes	No	No	No	
1	0	1	Unprotected areas	Yes	Yes	Yes	No	
1	0	1	Protected areas	Yes	No	No	No	
1	1	0	All program memory	Yes	No	Yes	Yes	
1	1	1	All program memory	Yes	Yes	Yes	Yes	

TABLE 4-2:	REGISTERS ASSOCIATED WITH DATA EEPROM/PROGRAM FLASH

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh, 18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	RBIF	0000 000x	0000 000u
10Dh	EEADR	EEPRON	Address	s Register	, Low Byt	е				xxxx xxxx	uuuu uuuu
10Fh	EEADRH	—	—	—	EEPROM Address, High Byte					xxxx xxxx	uuuu uuuu
10Ch	EEDATA	EEPRON	EEPROM Data Register, Low Byte							xxxx xxxx	uuuu uuuu
10Eh	EEDATH	—	—	EEPRO	M Data Re	egister, Hig	h Byte			xxxx xxxx	uuuu uuuu
18Ch	EECON1	EEPGD	_	_	—	WRERR	WREN	WR	RD	x x000	x u000
18Dh	EECON2	EEPRON	EPROM Control Register2 (not a physical register)						_	_	
8Dh	PIE2	—	(1)		EEIE	BCLIE	—	_	CCP2IE	-r-0 00	-r-0 00
0Dh	PIR2	_	(1)	_	EEIF	BCLIF	_	_	CCP2IF	-r-0 00	-r-0 00

Legend: x = unknown, u = unchanged, r = reserved, - = unimplemented, read as '0'. Shaded cells are not used during FLASH/EEPROM access.

Note 1: These bits are reserved; always maintain these bits clear.

8.0 CAPTURE/COMPARE/PWM MODULES

Each Capture/Compare/PWM (CCP) module contains a 16-bit register which can operate as a:

- 16-bit Capture register
- 16-bit Compare register
- PWM Master/Slave Duty Cycle register

Both the CCP1 and CCP2 modules are identical in operation, with the exception being the operation of the special event trigger. Table 8-1 and Table 8-2 show the resources and interactions of the CCP module(s). In the following sections, the operation of a CCP module is described with respect to CCP1. CCP2 operates the same as CCP1, except where noted.

CCP1 Module:

Capture/Compare/PWM Register1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON register controls the operation of CCP1. The special event trigger is generated by a compare match and will reset Timer1.

CCP2 Module:

Capture/Compare/PWM Register2 (CCPR2) is comprised of two 8-bit registers: CCPR2L (low byte) and CCPR2H (high byte). The CCP2CON register controls the operation of CCP2. The special event trigger is generated by a compare match and will reset Timer1 and start an A/D conversion (if the A/D module is enabled).

Additional information on CCP modules is available in the PIC[®] MCU Mid-Range Family Reference Manual (DS33023) and in application note AN594, "Using the CCP Modules" (DS00594).

TABLE 8-1: CCP MODE - TIMER RESOURCES REQUIRED

CCP Mode	Timer Resource
Capture	Timer1
Compare	Timer1
PWM	Timer2

TABLE 8-2:INTERACTION OF TWO CCP MODULES

CCPx Mode	CCPy Mode	Interaction
Capture	Capture	Same TMR1 time-base
Capture	Compare	The compare should be configured for the special event trigger, which clears TMR1
Compare	Compare	The compare(s) should be configured for the special event trigger, which clears TMR1
PWM	PWM	The PWMs will have the same frequency and update rate (TMR2 interrupt)
PWM	Capture	None
PWM	Compare	None

8.3 PWM Mode (PWM)

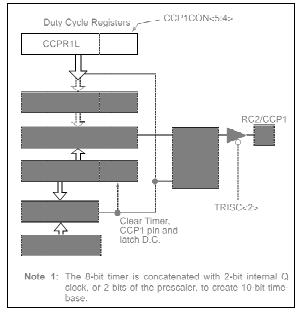
In Pulse Width Modulation mode, the CCPx pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note:	Clearing the CCP1CON register will force
	the CCP1 PWM output latch to the default
	low level. This is not the PORTC I/O data
	latch.

Figure 8-3 shows a simplified block diagram of the CCP module in PWM mode.

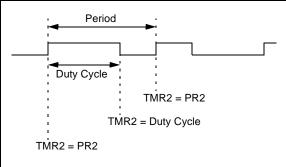
For a step-by-step procedure on how to set up the CCP module for PWM operation, see Section 8.3.3.

FIGURE 8-3: SIMPLIFIED PWM BLOCK DIAGRAM



A PWM output (Figure 8-4) has a time-base (period) and a time that the output stays high (duty cycle). The frequency of the PWM is the inverse of the period (1/period).





8.3.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following formula:

 $PWM period = [(PR2) + 1] \bullet 4 \bullet TOSC \bullet$ (TMR2 prescale value)

PWM frequency is defined as 1 / [PWM period].

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set (exception: if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is latched from CCPR1L into CCPR1H

Note: The Timer2 postscaler (see Section 7.1) is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

8.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The following equation is used to calculate the PWM duty cycle in time:

PWM duty cycle =(CCPR1L:CCP1CON<5:4>) • Tosc • (TMR2 prescale value)

CCPR1L and CCP1CON<5:4> can be written to at any time, but the duty cycle value is not latched into CCPR1H until after a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitch-free PWM operation.

When the CCPR1H and 2-bit latch match TMR2, concatenated with an internal 2-bit Q clock, or 2 bits of the TMR2 prescaler, the CCP1 pin is cleared.

The maximum PWM resolution (bits) for a given PWM frequency is given by the formula:

Resolution =
$$\frac{\log(\frac{FOSC}{FPWM})}{\log(2)}$$
 bits

Note: If the PWM duty cycle value is longer than the PWM period, the CCP1 pin will not be cleared.

9.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

The Master Synchronous Serial Port (MSSP) module is a serial interface, useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C)

Figure 9-1 shows a block diagram for the SPI mode, while Figure 9-5 and Figure 9-9 show the block diagrams for the two different I^2C modes of operation.

The Application Note AN734, "Using the PIC[®] MCU SSP for Slave I²CTM Communication" describes the slave operation of the MSSP module on the PIC16F87X devices. AN735, "Using the PIC[®] MCU MSSP Module for I²CTM Communications" describes the master operation of the MSSP module on the PIC16F87X devices.

SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS: 94h) REGISTER 9-1: R/W-0 R/W-0 R-0 R-0 R-0 R-0 R-0 R-0 SMP D/A Р R/W BF CKE S UA bit 7 bit 0 bit 7 SMP: Sample bit SPI Master mode: 1 = Input data sampled at end of data output time 0 = Input data sampled at middle of data output time SPI Slave mode: SMP must be cleared when SPI is used in slave mode In I²C Master or Slave mode: 1 = Slew rate control disabled for standard speed mode (100 kHz and 1 MHz) 0 = Slew rate control enabled for high speed mode (400 kHz) bit 6 CKE: SPI Clock Edge Select (Figure 9-2, Figure 9-3 and Figure 9-4) SPI mode: For CKP = 0 1 = Data transmitted on rising edge of SCK 0 = Data transmitted on falling edge of SCK For CKP = 1 1 = Data transmitted on falling edge of SCK 0 = Data transmitted on rising edge of SCK In I²C Master or Slave mode: 1 = Input levels conform to SMBus spec 0 = Input levels conform to I²C specs **D/A**: Data/Address bit (I²C mode only) bit 5 1 = Indicates that the last byte received or transmitted was data 0 = Indicates that the last byte received or transmitted was address bit 4 P: STOP bit (I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a STOP bit has been detected last (this bit is '0' on RESET) 0 = STOP bit was not detected last bit 3 S: START bit (I²C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.) 1 = Indicates that a START bit has been detected last (this bit is '0' on RESET) 0 = START bit was not detected last bit 2 **R/W**: Read/Write bit Information (I²C mode only) This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next START bit, STOP bit or not ACK bit. In I²C Slave mode: 1 = Read0 = WriteIn I²C Master mode: 1 = Transmit is in progress 0 = Transmit is not in progress Logical OR of this bit with SEN, RSEN, PEN, RCEN, or ACKEN will indicate if the MSSP is in IDLE mode. bit 1 **UA**: Update Address (10-bit I²C mode only) 1 = Indicates that the user needs to update the address in the SSPADD register 0 = Address does not need to be updated bit BF: Buffer Full Status bit Receive (SPI and I²C modes): 1 = Receive complete, SSPBUF is full 0 = Receive not complete, SSPBUF is empty Transmit (I²C mode only): 1 = Data transmit in progress (does not include the ACK and STOP bits), SSPBUF is full 0 = Data transmit complete (does not include the ACK and STOP bits), SSPBUF is empty Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

- n = Value at POR

'1' = Bit is set

x = Bit is unknown

'0' = Bit is cleared

9.1.2 SLAVE MODE

In Slave mode, the data is transmitted and received as the external clock pulses appear on SCK. When the last bit is latched, the interrupt flag bit SSPIF (PIR1<3>) is set.

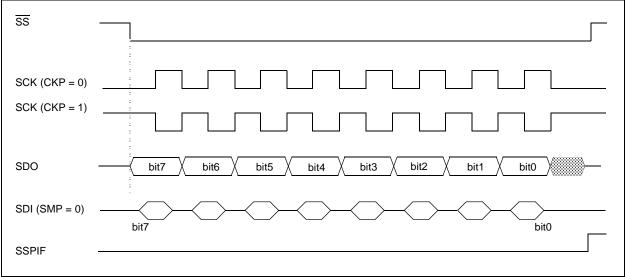
While in Slave mode, the external clock is supplied by the external clock source on the SCK pin. This external clock must meet the minimum high and low times as specified in the electrical specifications. While in SLEEP mode, the slave can transmit/receive data. When a byte is received, the device will wake-up from SLEEP.

- Note 1: When the <u>SPI</u> module is in Slave mode with <u>SS</u> pin control enabled (SSPCON<3:0> = 0100), the SPI module will reset if the <u>SS</u> pin is set to VDD.
 - 2: If the SPI is used in Slave mode with CKE = '1', then SS pin control must be enabled.

SCK (CKP = 0) SCK (CKP = 1) SD0 SD0 SD1 (SMP = 0) B17 SD1 SD1

FIGURE 9-3: SPI MODE TIMING (SLAVE MODE WITH CKE = 0)





9.2 MSSP I²C Operation

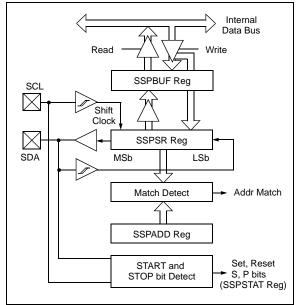
The MSSP module in I²C mode, fully implements all master and slave functions (including general call support) and provides interrupts on START and STOP bits in hardware, to determine a free bus (multi-master function). The MSSP module implements the standard mode specifications, as well as 7-bit and 10-bit addressing.

Refer to Application Note AN578, "Use of the SSP Module in the I²C Multi-Master Environment."

A "glitch" filter is on the SCL and SDA pins when the pin is an input. This filter operates in both the 100 kHz and 400 kHz modes. In the 100 kHz mode, when these pins are an output, there is a slew rate control of the pin that is independent of device frequency.

FIGURE 9-5:

I²C SLAVE MODE BLOCK DIAGRAM



Two pins are used for data transfer. These are the SCL pin, which is the clock, and the SDA pin, which is the data. The SDA and SCL pins are automatically configured when the l^2C mode is enabled. The SSP module functions are enabled by setting SSP Enable bit SSPEN (SSPCON<5>).

The MSSP module has six registers for $\mathsf{I}^2\mathsf{C}$ operation. They are the:

- SSP Control Register (SSPCON)
- SSP Control Register2 (SSPCON2)
- SSP Status Register (SSPSTAT)
- Serial Receive/Transmit Buffer (SSPBUF)
- SSP Shift Register (SSPSR) Not directly accessible
- SSP Address Register (SSPADD)

The SSPCON register allows control of the I²C operation. Four mode selection bits (SSPCON<3:0>) allow one of the following I²C modes to be selected:

- I²C Slave mode (7-bit address)
- I²C Slave mode (10-bit address)
- I²C Master mode, clock = OSC/4 (SSPADD +1)
- I²C firmware modes (provided for compatibility to other mid-range products)

Before selecting any I^2C mode, the SCL and SDA pins must be programmed to inputs by setting the appropriate TRIS bits. Selecting an I^2C mode by setting the SSPEN bit, enables the SCL and SDA pins to be used as the clock and data lines in I^2C mode. Pull-up resistors must be provided externally to the SCL and SDA pins for the proper operation of the I^2C module.

The CKE bit (SSPSTAT<6:7>) sets the levels of the SDA and SCL pins in either Master or Slave mode. When CKE = 1, the levels will conform to the SMBus specification. When CKE = 0, the levels will conform to the I^2C specification.

The SSPSTAT register gives the status of the data transfer. This information includes detection of a START (S) or STOP (P) bit, specifies if the received byte was data or address, if the next byte is the completion of 10-bit address, and if this will be a read or write data transfer.

SSPBUF is the register to which the transfer data is written to, or read from. The SSPSR register shifts the data in or out of the device. In receive operations, the SSPBUF and SSPSR create a doubled buffered receiver. This allows reception of the next byte to begin before reading the last byte of received data. When the complete byte is received, it is transferred to the SSPBUF register and flag bit SSPIF is set. If another complete byte is received before the SSPBUF register is read, a receiver overflow has occurred and bit SSPOV (SSPCON<6>) is set and the byte in the SSPSR is lost.

The SSPADD register holds the slave address. In 10-bit mode, the user needs to write the high byte of the address (1111 0 A9 A8 0). Following the high byte address match, the low byte of the address needs to be loaded (A7:A0).

9.2.10 I²C MASTER MODE REPEATED START CONDITION TIMING

A Repeated START condition occurs when the RSEN bit (SSPCON2<1>) is programmed high and the I^2C module is in the IDLE state. When the RSEN bit is set, the SCL pin is asserted low. When the SCL pin is sampled low, the baud rate generator is loaded with the contents of SSPADD<6:0> and begins counting. The SDA pin is released (brought high) for one baud rate generator count (TBRG). When the baud rate generator times out, if SDA is sampled high, the SCL pin will be de-asserted (brought high). When SCL is sampled high the baud rate generator is reloaded with the contents of SSPADD<6:0> and begins counting. SDA and SCL must be sampled high for one TBRG. This action is then followed by assertion of the SDA pin (SDA is low) for one TBRG, while SCL is high. Following this, the RSEN bit in the SSPCON2 register will be automatically cleared and the baud rate generator will not be reloaded, leaving the SDA pin held low. As soon as a START condition is detected on the SDA and SCL pins, the S bit (SSPSTAT<3>) will be set. The SSPIF bit will not be set until the baud rate generator has timed out.

- **Note 1:** If RSEN is programmed while any other event is in progress, it will not take effect.
 - 2: A bus collision during the Repeated START condition occurs if:
 - SDA is sampled low when SCL goes from low to high.
 - SCL goes low before SDA is asserted low. This may indicate that another master is attempting to transmit a data "1".

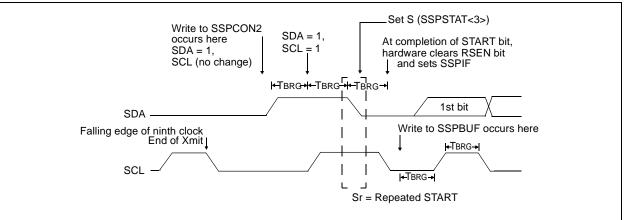
Immediately following the SSPIF bit getting set, the user may write the SSPBUF with the 7-bit address in 7-bit mode, or the default first address in 10-bit mode. After the first eight bits are transmitted and an ACK is received, the user may then transmit an additional eight bits of address (10-bit mode), or eight bits of data (7-bit mode).

9.2.10.1 WCOL Status Flag

If the user writes the SSPBUF when a Repeated START sequence is in progress, then WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note: Because queueing of events is not allowed, writing of the lower 5 bits of SSPCON2 is disabled until the Repeated START condition is complete.

FIGURE 9-13: REPEAT START CONDITION WAVEFORM



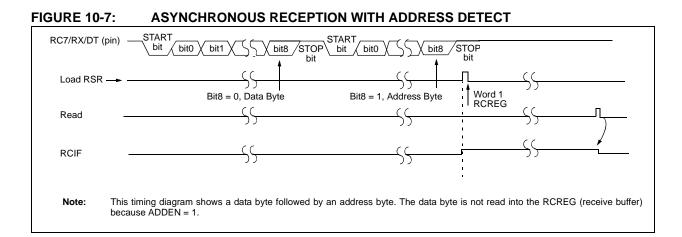


FIGURE 10-8: ASYNCHRONOUS RECEPTION WITH ADDRESS BYTE FIRST

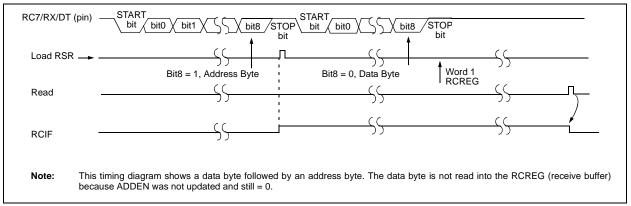


TABLE 10-7: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	R0IF	x000 0000x	0000 000u
0Ch	PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	0000 000x
1Ah	RCREG	USART Re	USART Receive Register							0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate Generator Register							0000 0000	0000 0000	

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception. Note 1: Bits PSPIE and PSPIF are reserved on PIC16F873/876 devices; always maintain these bits clear.

11.2 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires a minimum 12TAD per 10-bit conversion. The source of the A/D conversion clock is software selected. The four possible options for TAD are:

- 2Tosc
- 8Tosc
- 32Tosc
- Internal A/D module RC oscillator (2-6 μs)

For correct A/D conversions, the A/D conversion clock (TAD) must be selected to ensure a minimum TAD time of 1.6 $\mu s.$

Table 11-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

TABLE 11-1: TAD VS. MAXIMUM DEVICE OPERATING FREQUENCIES (STANDARD DEVICES (C))

AD Clock	AD Clock Source (TAD)				
Operation	ADCS1:ADCS0	Max.			
2Tosc	0 0	1.25 MHz			
8Tosc	01	5 MHz			
32Tosc	10	20 MHz			
RC ^(1, 2, 3)	11	(Note 1)			

Note 1: The RC source has a typical TAD time of 4 μ s, but can vary between 2-6 μ s.

2: When the device frequencies are greater than 1 MHz, the RC A/D conversion clock source is only recommended for SLEEP operation.

3: For extended voltage devices (LC), please refer to the Electrical Characteristics (Sections 15.1 and 15.2).

11.3 Configuring Analog Port Pins

The ADCON1 and TRIS registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS2:CHS0 bits and the TRIS bits.

Note	1: When reading the port register, any pin
	configured as an analog input channel will
	read as cleared (a low level). Pins config-
	ured as digital inputs will convert an ana-
	log input. Analog levels on a digitally
	configured input will not affect the conver-
	sion accuracy.

2: Analog levels on any pin that is defined as a digital input (including the AN7:AN0 pins), may cause the input buffer to consume current that is out of the device specifications.

12.13 Power-down Mode (SLEEP)

Power-down mode is entered by executing a $\ensuremath{\mathtt{SLEEP}}$ instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit (STATUS<3>) is cleared, the TO (STATUS<4>) bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had before the SLEEP instruction was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, place all I/O pins at either VDD or VSS, ensure no external circuitry is drawing current from the I/O pin, power-down the A/D and disable external clocks. Pull all I/O pins that are hi-impedance inputs, high or low externally, to avoid switching currents caused by floating inputs. The TOCKI input should also be at VDD or VSS for lowest current consumption. The contribution from on-chip pull-ups on PORTB should also be considered.

The MCLR pin must be at a logic high level (VIHMC).

12.13.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

- 1. External RESET input on MCLR pin.
- 2. Watchdog Timer Wake-up (if WDT was enabled).
- 3. Interrupt from INT pin, RB port change or peripheral interrupt.

External MCLR Reset will cause a device RESET. All other events are considered a continuation of program execution and cause a "wake-up". The TO and PD bits in the STATUS register can be used to determine the cause of device RESET. The PD bit, which is set on power-up, is cleared when SLEEP is invoked. The TO bit is cleared if a WDT time-out occurred and caused wake-up.

The following peripheral interrupts can wake the device from SLEEP:

- 1. PSP read or write (PIC16F874/877 only).
- 2. TMR1 interrupt. Timer1 must be operating as an asynchronous counter.
- 3. CCP Capture mode interrupt.
- 4. Special event trigger (Timer1 in Asynchronous mode using an external clock).
- 5. SSP (START/STOP) bit detect interrupt.
- SSP transmit or receive in Slave mode (SPI/I²C).
- 7. USART RX or TX (Synchronous Slave mode).
- 8. A/D conversion (when A/D clock source is RC).
- 9. EEPROM write operation completion

Other peripherals cannot generate interrupts since during SLEEP, no on-chip clocks are present. When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

12.13.2 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a SLEEP instruction, the SLEEP instruction will complete as a NOP. Therefore, the WDT and WDT postscaler will not be cleared, the TO bit will not be set and PD bits will not be cleared.
- If the interrupt occurs during or after the execution of a SLEEP instruction, the device will immediately wake-up from SLEEP. The SLEEP instruction will be completely executed before the wake-up. Therefore, the WDT and WDT postscaler will be cleared, the TO bit will be set and the PD bit will be cleared.

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the PD bit. If the PD bit is set, the SLEEP instruction was executed as a NOP.

To ensure that the WDT is cleared, a CLRWDT instruction should be executed before a SLEEP instruction.

	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1		Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4	Q1 Q2 Q3 Q4
OSC1	·/~~~~/			- ANNON		<u>;</u> ~~~~~~		
CLKOUT ⁽⁴⁾	\/\		<u> </u>	Tost(2)	/	\	¦/ \	
INT pin	· · ·	1		· ·		1 1	1 I 1 I	
INTF Flag (INTCON<1>)		י י י י	4	/		Interrupt Latency	(2)	
GIE bit (INTCON<7>)	1 I 1 I 1 I 1 I 1 I	i 	Processor i	n		·	1 1 1 1 1 1	ו ו ו ו
INSTRUCTIO	N FLOW			· ·		1	1 1 1 1	1
PC	Х РС Х	PC+1	ХР	C+2	PC+2	X PC + 2	<u>X 0004h X</u>	0005h
Instruction { Fetched {	Inst(PC) = SLEEP	Inst(PC + 1)		1	Inst(PC + 2)	1 1 1	Inst(0004h)	Inst(0005h)
Instruction	Inst(PC - 1)	SLEEP		, , ,	Inst(PC + 1)	Dummy cycle	Dummy cycle	Inst(0004h)
2: Tost	HS or LP oscillator n τ = 1024Tosc (drawi = '1' assumed. In th	ing not to scale)						

F

If GIE = '0', execution will continue in-line.

4: CLKOUT is not available in these osc modes, but shown here for timing reference.

12.14 In-Circuit Debugger

When the DEBUG bit in the configuration word is programmed to a '0', the In-Circuit Debugger functionality is enabled. This function allows simple debugging functions when used with MPLAB® ICD. When the microcontroller has this feature enabled, some of the resources are not available for general use. Table 12-8 shows which features are consumed by the background debugger.

TABLE 12-8: DE	BUGGER RESOURCES
----------------	------------------

I/O pins	RB6, RB7				
Stack	1 level				
Program Memory	Address 0000h must be NOP				
	Last 100h words				
Data Memory	0x070 (0x0F0, 0x170, 0x1F0) 0x1EB - 0x1EF				

To use the In-Circuit Debugger function of the microcontroller, the design must implement In-Circuit Serial Programming connections to MCLR/VPP, VDD, GND, RB7 and RB6. This will interface to the In-Circuit Debugger module available from Microchip, or one of the third party development tool companies.

12.15 Program Verification/Code Protection

If the code protection bit(s) have not been programmed, the on-chip program memory can be read out for verification purposes.

12.16 ID Locations

Four memory locations (2000h - 2003h) are designated as ID locations, where the user can store checksum or other code identification numbers. These locations are not accessible during normal execution, but are readable and writable during program/verify. It is recommended that only the 4 Least Significant bits of the ID location are used.

14.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK object linker combines relocatable objects created by the MPASM assembler and the MPLAB C17 and MPLAB C18 C compilers. It can also link relocatable objects from pre-compiled libraries, using directives from a linker script.

The MPLIB object librarian is a librarian for precompiled code to be used with the MPLINK object linker. When a routine from a library is called from another source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications. The MPLIB object librarian manages the creation and modification of library files.

The MPLINK object linker features include:

- Integration with MPASM assembler and MPLAB C17 and MPLAB C18 C compilers.
- Allows all memory areas to be defined as sections to provide link-time flexibility.

The MPLIB object librarian features include:

- Easier linking because single libraries can be included instead of many smaller files.
- Helps keep code maintainable by grouping related modules together.
- Allows libraries to be created and modules to be added, listed, replaced, deleted or extracted.

14.5 MPLAB SIM Software Simulator

The MPLAB SIM software simulator allows code development in a PC-hosted environment by simulating the PIC MCU series microcontrollers on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a file, or user-defined key press, to any of the pins. The execution can be performed in single step, execute until break, or trace mode.

The MPLAB SIM simulator fully supports symbolic debugging using the MPLAB C17 and the MPLAB C18 C compilers and the MPASM assembler. The software simulator offers the flexibility to develop and debug code outside of the laboratory environment, making it an excellent multiproject software development tool.

14.6 MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE

The MPLAB ICE universal in-circuit emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC MCU microcontrollers (MCUs). Software control of the MPLAB ICE in-circuit emulator is provided by the MPLAB Integrated Development Environment (IDE), which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The universal architecture of the MPLAB ICE in-circuit emulator allows expansion to support new PIC microcontrollers.

The MPLAB ICE in-circuit emulator system has been designed as a real-time emulation system, with advanced features that are generally found on more expensive development tools. The PC platform and Microsoft[®] Windows environment were chosen to best make these features available to you, the end user.

14.7 ICEPIC In-Circuit Emulator

The ICEPIC low cost, in-circuit emulator is a solution for the Microchip Technology PIC16C5X, PIC16C6X, PIC16C7X and PIC16CXXX families of 8-bit One-Time-Programmable (OTP) microcontrollers. The modular system can support different subsets of PIC16C5X or PIC16CXXX products through the use of interchangeable personality modules, or daughter boards. The emulator is capable of emulating without target application circuitry being present.

15.2 DC Characteristics: PIC16F873/874/876/877-04 (Commercial, Industrial) PIC16F873/874/876/877-20 (Commercial, Industrial) PIC16LF873/874/876/877-04 (Commercial, Industrial) (Continued)

DC CHARACTERISTICS			$\begin{array}{llllllllllllllllllllllllllllllllllll$					
Param No.	Sym	Characteristic	Min	Тур†	Мах	Units	Conditions	
	Vol	Output Low Voltage						
D080		I/O ports			0.6	V	IOL = 8.5 mA, VDD = 4.5V, -40°C to +85°C	
D083		OSC2/CLKOUT (RC osc config)	—	—	0.6	V	IOL = 1.6 mA, VDD = 4.5V, -40°C to +85°C	
	Voн	Output High Voltage						
D090		I/O ports ⁽³⁾	Vdd - 0.7		_	V	Юн = -3.0 mA, VDD = 4.5V, -40°С to +85°С	
D092		OSC2/CLKOUT (RC osc config)	Vdd - 0.7	_	—	V	IOH = -1.3 mA, VDD = 4.5V, -40°С to +85°С	
D150*	Vod	Open-Drain High Voltage		_	8.5	V	RA4 pin	
		Capacitive Loading Specs on Output Pins						
D100	Cosc2	OSC2 pin	_		15	pF	In XT, HS and LP modes when external clock is used to drive OSC1	
D101	Cio	All I/O pins and OSC2 (RC mode)	_	—	50	pF		
D102	Св	SCL, SDA (I ² C mode)		_	400	pF		
		Data EEPROM Memory						
D120	ED	Endurance	100K	—	—		25°C at 5V	
D121	Vdrw	VDD for read/write	Vmin	—	5.5	V	Using EECON to read/write VMIN = min. operating voltage	
D122	TDEW	Erase/write cycle time		4	8	ms		
		Program FLASH Memory						
D130	Eр	Endurance	1000	—	—		25°C at 5V	
D131	Vpr	VDD for read	Vmin	—	5.5	V	VMIN = min operating voltage	
D132A		VDD for erase/write	Vmin	—	5.5	V	Using EECON to read/write, VMIN = min. operating voltage	
D133		Erase/Write cycle time		4	8	ms		

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC16F87X be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.